

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 09/392,073  
Priority Filing Date .... September 8, 1999  
Inventor .... Rickie C. Lake, et al  
Assignee .... Micron Technology, Inc.  
Priority Group Art Unit .... 1751  
Priority Examiner .... D. Hamlin  
Attorney's Docket No. .... MI40-327  
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive Adhesive  
Connection

#2A  
NEAL

PRELIMINARY AMENDMENT

To: Box Patent Application  
Assistant Commissioner for Patents  
Washington, D.C. 20231

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AMENDMENTS

In the Specification

Page 1, after the title, insert:

-CROSS REFERENCE TO RELATED APPLICATION

This patent resulted from a Continuation of U.S. Patent Application Serial  
No. 09/392,073, filed September 8, 1999, which is a Divisional of U.S. Patent  
Application Serial No. 09/032,262, filed February 27, 1998.--

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